onsemi

MOSFET – N-Channel, SUPERFET[®] II

600 V, 52 A, 72 m Ω

FCH072N60

Description

SUPERFET II MOSFET is **onsemi**'s brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SUPERFET II MOSFET is suitable for various AC/DC power conversion for system miniaturization and higher efficiency.

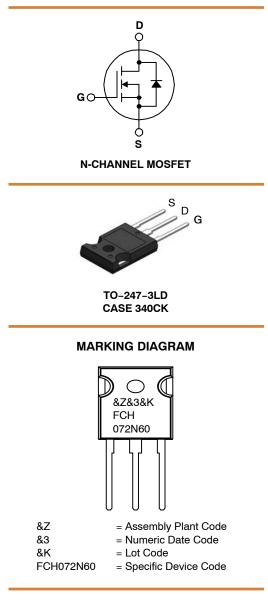
Features

- Typ. $R_{DS(on)} = 66 \text{ m}\Omega$
- 650 V @ $T_J = 150^{\circ}C$
- Ultra Low Gate Charge (Typ. Q_g = 95 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 421 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Telecom / Sever Power Supplies
- Industrial Power Supplies

| V _{DS} | R _{DS(ON)} MAX | I _D MAX |
|-----------------|-------------------------|--------------------|
| 600 V | 72 m Ω @ 10 V | 52 A |



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

| Symbol | Parameter | FCH072N60 | Unit | |
|-----------------------------------|--|---------------------------------------|--------------|------|
| V _{DSS} | Drain to Source Voltage | | 600 | V |
| V _{GSS} | Gate to Source Voltage - DC | | ±20 | V |
| | | – AC (f > 1 Hz) | ±30 | |
| ID | Drain Current: | – Continuous (T _C = 25°C) | 52 | А |
| | | – Continuous (T _C = 100°C) | 33 | 1 |
| I _{DM} | Drain Current: | - Pulsed (Note 1) | 156 | А |
| E _{AS} | Single Pulsed Avalanche Energy (Note 2) | | 1128 | mJ |
| I _{AR} | Avalanche Current (Note 1) | | 9.5 | А |
| E _{AR} | Repetitive Avalanche Energy (Note 1) | | 4.8 | mJ |
| dv/dt | MOSFET dv/dt | | | V/ns |
| | Peak Diode Recovery dv/dt (Note 3) | | 20 | |
| PD | Power Dissipation | (T _C = 25°C) | 481 | W |
| | – Derate Above 25°C | | 3.85 | W/°C |
| T _J , T _{STG} | Operating and Storage Temperature Range | | –55 to + 150 | °C |
| ΤL | Maximum Lead Temperature for Soldering, 1/ | 8" from Case for 5 seconds | 300 | °C |

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality shows be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 9.5 \text{ A}, R_G = 25 \Omega$, Starting $T_J = 25 \text{ °C}$. 3. $I_{SD} \le 26 \text{ A}, \text{ di/dt} \le 200 \text{ A/}\mu\text{s}, \text{V}_{DD} \le 380 \text{ V}$, Starting $T_J = 25 \text{ °C}$.

PACKAGE MARKING AND ORDERING INFORMATION

| Part Number | Top Marking | Package | Packing Method | Reel Size | Tape Width | Quantity |
|-------------|-------------|---------|----------------|-----------|------------|----------|
| FCH072N60 | FCH072N60 | TO-247 | Tube | N/A | N/A | 30 Units |

THERMAL CHARACTERISTICS

| Symbol | Parameter FCH072N60 | | Unit |
|---------------------|---|------|------|
| $R_{	ext{	heta}JC}$ | Thermal Resistance, Junction to Case, Max. | 0.26 | °C/W |
| $R_{	ext{	heta}JA}$ | Thermal Resistance, Junction to Ambient, Max. | 40 | |



ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

| Symbol | Parameter | Test Condition | Min. | Тур. | Max. | Unit |
|--------------------------------|--|---|------|------|------|------|
| OFF CHARA | ACTERISTICS | | | | - | - |
| BV _{DSS} | Drain to Source Breakdown Voltage | I_D = 10 mA, V_{GS} = 0 V, T_J = 25°C | 600 | - | - | V |
| | | I_D = 10 mA, V_{GS} = 0 V, T_J = 150°C | 650 | - | - | |
| $\Delta BV_{DSS} / \Delta T_J$ | Breakdown Voltage Temperature Coefficient | I_D = 10 mA, Referenced to 25°C | _ | 0.67 | _ | V/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | V_{DS} = 600 V, V_{GS} = 0 V | - | - | 1 | μΑ |
| | | V_{DS} = 480 V, V_{GS} = 0 V, T_{C} = 125 $^{\circ}C$ | - | 4.1 | - | |
| I _{GSS} | Gate to Body Leakage Current | V_{GS} = ± 20 V, V_{DS} = 0 V | - | - | ±100 | nA |
| N CHARA | CTERISTICS | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | V _{GS} = V _{DS} , I _D = 250 μA | 2.5 | - | 3.5 | V |

| VGS(th) | Gate Threshold Voltage | $V_{GS} = V_{DS}$, $I_D = 250 \mu A$ | 2.5 | - | 3.5 | V |
|---------------------|--------------------------------------|---|-----|----|-----|----|
| R _{DS(on)} | Static Drain to Source On Resistance | V_{GS} = 10 V, I _D = 26 A | - | 66 | 72 | mΩ |
| 9 _{FS} | Forward Transconductance | $V_{DS} = 20 \text{ V}, \text{ I}_{D} = 26 \text{ A}$ | _ | 48 | - | S |

DYNAMIC CHARACTERISTICS

| C _{iss} | Input Capacitance | V_{DS} = 380 V, V_{GS} = 0 V, f = 1 MHz | - | 4430 | 5890 | pF |
|------------------------|-------------------------------|---|---|------|------|----|
| C _{oss} | Output Capacitance | | - | 115 | 155 | pF |
| C _{rss} | Reverse Transfer Capacitance | | - | 4.43 | - | pF |
| C _{oss(eff.)} | Effective Output Capacitance | V_{DS} = 0 V to 480 V, V_{GS} = 0 V | - | 421 | - | pF |
| Q _{g(tot)} | Total Gate Charge at 10 V | $V_{DS} = 380 \text{ V}, \text{ I}_{D} = 26 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$ | - | 95 | 125 | nC |
| Q _{gs} | Gate to Source Gate Charge | (Note 4) | - | 21 | - | nC |
| Q _{gd} | Gate to Drain "Miller" Charge | | - | 24 | - | nC |
| ESR | Equivalent Series Resistance | f = 1 MHz | - | 0.93 | - | Ω |

SWITCHING CHARACTERISTICS

| t _{d(on)} | Turn-On Delay Time | $V_{DD} = 380 \text{ V}, \text{ I}_{D} = 26 \text{ A},$ | - | 33 | 76 | ns |
|---------------------|---------------------|--|---|-----|-----|----|
| t _r | Turn-On Rise Time | V _{GS} = 10 V, R _g = 4.7 Ω (Note 4) | - | 23 | 56 | ns |
| t _{d(off)} | Turn-Off Delay Time | | - | 97 | 204 | ns |
| t _f | Turn-Off Fall Time | | - | 3.5 | 17 | ns |

DRAIN-SOURCE DIODE CHARACTERISTICS

| ۱ _S | Maximum Continuous Source to Drain Diode Forward Current | | - | - | 52 | A |
|-----------------|--|---|---|-----|-----|----|
| I _{SM} | Maximum Pulsed Drain to Source Diode Forward Current | | - | - | 156 | А |
| V _{SD} | Drain to Source Diode Forward Voltage | $V_{GS} = 0 \text{ V}, \text{ I}_{SD} = 26 \text{ A}$ | - | - | 1.2 | V |
| t _{rr} | Reverse Recovery Time | $V_{GS} = 0 V, I_{SD} = 26 A,$ | - | 495 | - | ns |
| Q _{rr} | Reverse Recovery Charge | dl _F /dt = 100 A/μs | - | 13 | - | μC |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature.



TYPICAL CHARACTERISTICS

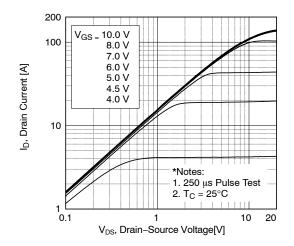


Figure 1. On-Region Characteristics

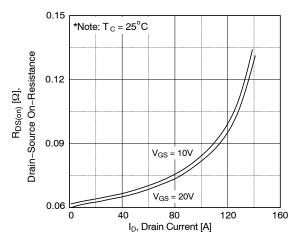


Figure 3. On–Resistance Variation vs. Drain Current and Gate Voltage

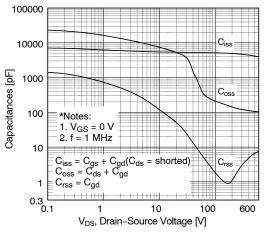


Figure 5. Capacitance Characteristics

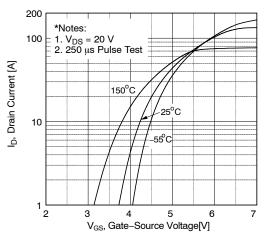


Figure 2. Transfer Characteristics

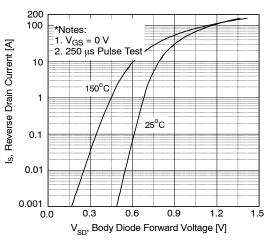
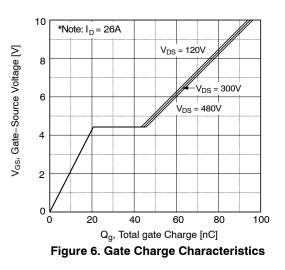


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature





TYPICAL CHARACTERISTICS

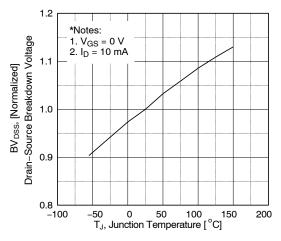


Figure 7. Breakdown Voltage Variation vs. Temperature

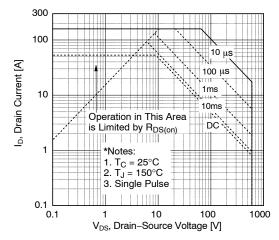


Figure 9. Maximum Safe Operating Area

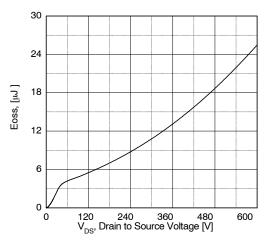


Figure 11. Eoss vs. Drain to Source Voltage

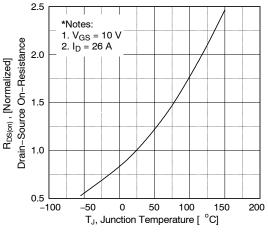


Figure 8. On–Resistance Variation vs. Temperature

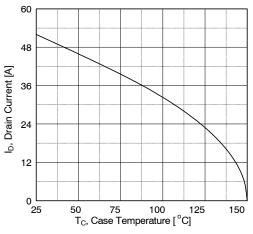
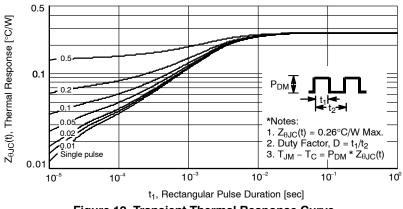


Figure 10. Maximum Drain Current vs. Case Temperature

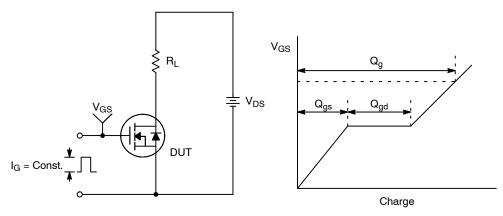


TYPICAL CHARACTERISTICS











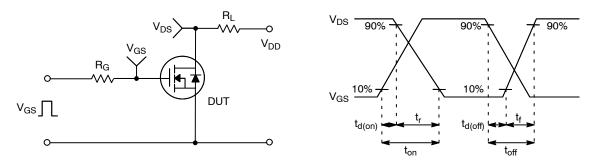


Figure 14. Resistive Switching Test Circuit & Waveforms

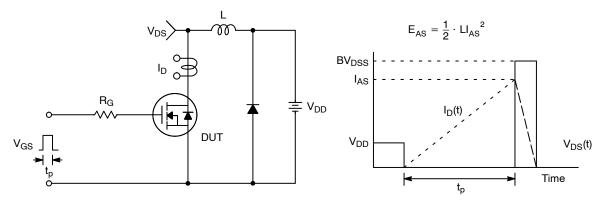


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms



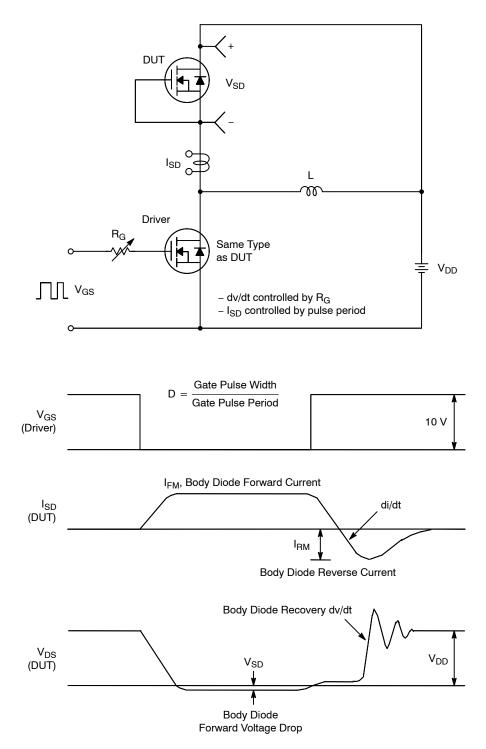


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

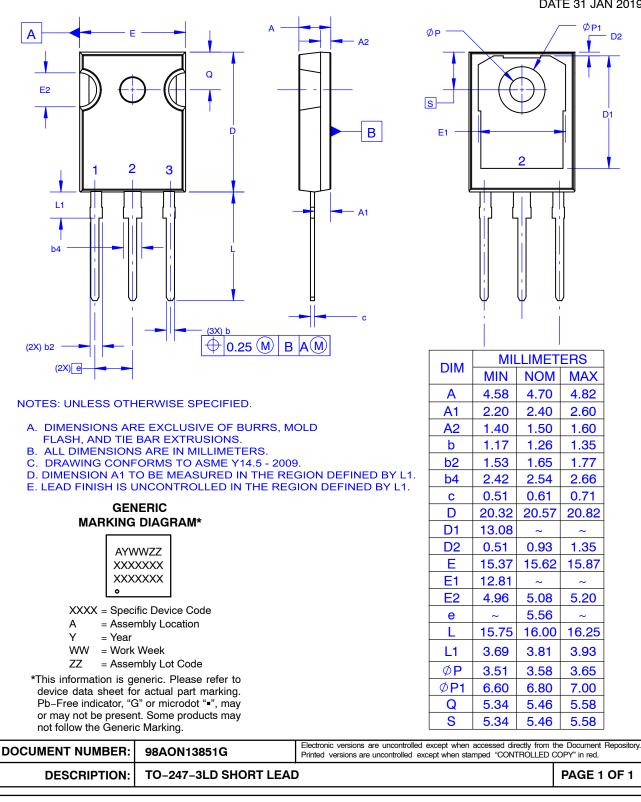
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